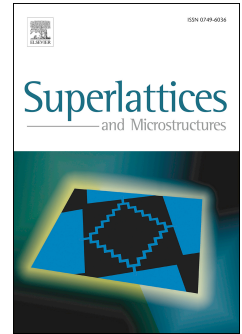


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Texture of Al Films for Wafer-Level Thermocompression Bonding

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